

DI2-16 for imc CRONOS-SL/compact

16 digital inputs

The plug-in module DI2-16 for imc CRONOS *compact* (or configuration module for CRONOS-SL) provides sampling of digital inputs having TTL/CMOS or 24 V logic levels. The level can be set separately for each group of eight inputs. The groups are jointly isolated from the system.

imc CRONOS compact- modular measurement system

imc CRONOS *compact* is a modular and reconfigurable hardware a "rack"-based series of devices available in a variety of housing sizes and device frames. imc CRONOS *compact* (CRC) plug-in-modules can be inserted into the system (CRC-400 / CRC-2000G).

Once the modules are plugged into a portable or rack-based housing, they are electrically connected to the CRC-system and are supplied by the system with power. The data storage will be managed by the CRC-system.

Rack-based modules ("-R") differ from the standard modules only in terms of the front panel's attachment mechanism.



imc CRONOScompact plug-in-modules



imc CRONOScompact portable housing

Overview of the available variants

Standard version		ET Version *	
Order Code:	article no.	article no.	Remarks
CRC/DI2-16	11700065	11710039	for imc CRONOS compact
CRC/DI2-16-R	11700128	11710087	for imc CRONOS compact RACK
CRSL/DI2-16-D		11800xxx	CRONOS-SL variant with DSUB-15

Included accessories for imc CRONOS compact.

• 2x ACC/DSUBM-DI4-8, 15-pin DSUB connectors for each 8 bits

Optional accessories:

• ACC/DSUBM-DI4-8-IP65, 15-pin DSUB clamp terminal adapted to CRONOS-SL for each 8-bit group

^{*} ET: Version in extended temperature range



DI2-16 analog inputs

1	6	groups of 4 Bit with common ground reference,
		galvanic isolation between groups
		configurable globally for 8 Bit at DSUB using the "LEVEL" pin:
TTL		"LEVEL": Jumper to "LCOM"
24 V		"LEVEL": unconnected
differential		groups of 4 Bit galvanic isolation between groups of 4 Bit
±150 V		to system ground (housing, CHASSIS, PE) and between groups of 4 Bit (tested ±200 V)
		edge detection;
34 µs	130 µs	over entire temperature range
3 µs	30 µs	
typ. 400 μs ± 100 μs		delay from input transition to changing state available in imc Online FAMOS
	max. 500 μA	
$V_{Lmax} = 0.8 V$	V _{Hmin} = 2.0 V	
$V_{Lmax} = 5.0 V$	$V_{Hmin} = 8.0 V$	
5 V max. 100 mA		isolated reference ground of both "HCOM" and "LEVEL" is "LCOM"
DSUB-15 / 8 Bit		ACC/DSUBM-DI4-8
	24 differ ±1! 34 µs 3 µs typ. 400 µ V _{Lmax} = 0.8 V V _{Lmax} = 5.0 V 5 V max	24 V differential ±150 V 34 μs 3 μs 130 μs 30 μs typ. 400 μs ±100 μs max. 500 μA V _{Lmax} = 0.8 V V _{Lmax} = 5.0 V V _{Hmin} = 2.0 V V _{Hmin} = 8.0 V 5 V max. 100 mA